The YNS12S10 converter is not recommended for new designs and has been replaced by the YS12S10. Please refer to the YS12S10 data sheet for new product specifications.



### **Key Features & Benefits**

- RoHS lead free and lead-solder-exempt products
- are available
- Delivers up to 10 A (55 W)
- Extended input range 9.6 to 14 VDC
- No derating up to 85 °C (70 °C for 5 VDC)
- Surface-mount package
- Industry-standard footprint and pinout
- Small size and low-profile: 1.30" x 0.53" x 0.314"
   (33.02 mm x 13.46 mm x 7.98 mm)
- Weight: 0.22 oz [6.12 g]
- Co-planarity < 0.003"
- Synchronous Buck Converter topology
- Start up into pre-biased output
- No minimum load required
- Programmable output voltage via external resistor
- Operating ambient temperature: -40 °C to 85 °C
- Remote output sense
- Remote ON/OFF (positive or negative)
- Fixed-frequency operation
- Auto-reset output overcurrent protection
- Auto-reset overtemperature protection
- High reliability, MTBF approx. 27.2 million hours calculated per Telcordia TR-332, Method I Case 1
- All materials meet UL94, V-0 flammability rating
- UL60950 recognition in U.S. & Canada, and DEMKO certification per IEC/EN60950

### YNS12S10 DC-DC Converter

9.6 - 14 VDC Input; 0.7525 - 5.5 VDC Programmable @ 10 A

Bel Power Solutions point-of-load converters are recommended for use with regulated bus converters in an Intermediate Bus Architecture (IBA). The Y-Series of non-isolated DC-DC converters deliver up to 10 A of output current in an industry-standard surface-mount package. Operating from a 9.6 to 14 VDC input, the YNS12S10 converters are ideal choices for Intermediate Bus Architectures where Point-of-Load power (POL) delivery is generally a requirement. They provide an extremely tight regulated, programmable output voltage of 0.7525 to 5.5 VDC.

The Y-Series of converters provide exceptional thermal performance, even in high temperature environments with minimal airflow. No derating is required up to 85 °C (up to 70 °C for 5 VDC output), even without airflow at natural convection. This performance is accomplished through the use of advanced circuitry, packaging, and processing techniques to achieve a design possessing ultra-high efficiency, excellent thermal management, and a very low-body profile.

The low-body profile and the preclusion of heat sinks minimize impedance to system airflow, thus enhancing cooling for both upstream and downstream devices. The use of 100% automation for assembly, coupled with advanced power electronics, and thermal design, results in a product with extremely high reliability.

#### **Applications**

- Intermediate Bus Architectures
- Telecommunications
- Data communications
- Distributed Power Architectures
- Servers, Workstations

#### **Benefits**

- High efficiency no heat sink required
- Reduces Total Solution Board Area
- Tape and Reel Packing
- Compatible with Pick & Place Equipment
- Minimizes Part Numbers in Inventory

North America +1-866.513.2839

**Asia-Pacific** +86.755.29885888

**Europe, Middle East** +353 61 225 977



### **Electrical Specifications**

Conditions:  $T_A = 25$  °C, Airflow = 300 LFM (1.5 m/s), Vin = 12 VDC, Vout = 0.7525 - 5.5 VDC, unless otherwise specified.

PARAMETER	NOTES	MIN	TYP	MAX	UNITS
Absolute Maximum Ratings					
Input Voltage	Continuous	-0.3		15	VDC
Operating Ambient Temperature		-40		85	°C
Storage Temperature		-55		125	°C
Feature Characteristics					
Switching Frequency			300		kHz
Output Voltage Trim Range <sup>1</sup>	By external resistor, See Trim Table 1	0.7525		5.5	VDC
Remote Sense Compensation <sup>1</sup>				0.5	VDC
Turn-On Delay Time	Full resistive load				
With Vin (Converter Enabled, then Vin applied	) From Vin = Vin(min) to Vo = 0.1* Vo(nom)		3		ms
With Enable (Vin = Vin(nom) applied, then enabled			3		ms
Rise time <sup>2</sup> (Full resistive load)	From 0.1*Vo(nom) to 0.9*Vo(nom)		4		ms
·	Converter Off	-5		0.8	VDC
ON/OFF Control (Positive Logic) <sup>3</sup>	Converter On	2.4		Vin	VDC
	Converter Off	2.4		Vin	VDC
ON/OFF Control (Negative Logic) <sup>3</sup>	Converter On	-5		0.8	VDC
Input Characteristics					
Operating Input Voltage Range		9.6	12	14	VDC
Input Under Voltage Lockout		0.0			
Turn-on Threshold			9.0		VDC
Turn-off Threshold			8.5		VDC
Maximum Input Current	10 ADC Out @ 9.6 VDC In		0.0		,,,,
Maximum input Garront	V <sub>OUT</sub> = 5.0 VDC			5.5	ADC
	V <sub>OUT</sub> = 3.3 VDC			3.7	ADC
	V <sub>OUT</sub> = 2.5 VDC			2.8	ADC
	V <sub>OUT</sub> = 2.0 VDC			2.3	ADC
	V <sub>OUT</sub> = 1.8 VDC			2.1	ADC
	V <sub>OUT</sub> = 1.5 VDC			1.8	ADC
	V <sub>OUT</sub> = 1.2 VDC			1.5	ADC
	V <sub>OUT</sub> = 1.0 VDC			1.3	ADC
	V <sub>OUT</sub> = 0.7525 VDC			1.1	ADC
Input Stand-by Current (Converter disabled)	VOUT = 0.7323 VDC		5	1.1	mA
·	V <sub>OUT</sub> = 5.0 VDC		76		
Input No Load Current (Converter enabled)					mA m^
	V <sub>OUT</sub> = 3.3 VDC		60		mA
	V <sub>OUT</sub> = 2.5 VDC		45		mA
	V <sub>OUT</sub> = 2.0 VDC		41		mA
	V <sub>OUT</sub> = 1.8 VDC		38		mA
	V <sub>OUT</sub> = 1.5 VDC		35		mA
	$V_{OUT} = 1.2 \text{ VDC}$		33		mA
	V <sub>OUT</sub> = 1.0 VDC		30		mA
	$V_{OUT} = 0.7525 \text{ VDC}$		28		mA
Input Reflected-Ripple Current - is	See Fig. D for setup. (BW = 20 MHz)				
	$V_{OUT} = 5.0 \text{ VDC}$		36		mA <sub>P-P</sub>
	$V_{OUT} = 3.3 \text{ VDC}$		34		$mA_{P-P}$
	$V_{OUT} = 2.5 \text{ VDC}$		32		mA <sub>P-P</sub>
	$V_{OUT} = 2.0 \text{ VDC}$		31		$mA_{P-P}$
	$V_{OUT} = 1.8 \text{ VDC}$		30		$mA_{P-P}$





Vor. = 1.5 VDC   29   mA <sub>P-E</sub>   mA <sub>P-E</sub>   Vor. = 1.2 VDC   26   mA <sub>P-E</sub>   mA <sub>P-E</sub>   vor. = 1.0 VDC   23   mA <sub>P-E</sub>   mA <sub>P-</sub>						
Nour = 1.0 VDC				29		$mA_{P-P}$
Nour = 0.7525 VDC   20   mAccording   120 Hz   72   618		$V_{OUT} = 1.2 \text{ VDC}$		26		$mA_{P-P}$
Input Voltage Ripple Rejection   120 Hz   72    73    74    75		V <sub>OUT</sub> = 1.0 VDC		23		$mA_{P-P}$
Output Voltage Set Point (no load)         -1.5         Vout         +1.5         Volvot           Output Notage Set Point (no load)         Full resistive load         1         2         mV           Over Line         Full resistive load         1         2         mV           Output Voltage Range         Prom no load to full load         5         12         mV           Output Voltage Range         Over Line         From no load to full load         5         12         mV           Output Voltage Range         Over Line, load and temperature (Fig. D)         10         20         mV>x           Output Ripple and Noise = 20 MHz bandwidth         Over = 1.0 VDC         10         20         mV>x           Peak-to-Peak         Vour = 5.0 VDC         2         20         40         mV>x           External Load Capacitance         Plus full load (resistive)         1         5,00         μF           Min ESR > 10 mΩ         15         ADC         4DC         4DC           Output Current Limit Inception (loan)         5         15         ADC           Output Short-Circuit Current         Short = 10 μC ceramic. + 1 μC ceramic         150/(180°)         mV           Settling Time (Vour < 10% peak deviation)		$V_{\text{OUT}} = 0.7525 \text{ VDC}$		20		$mA_{P\text{-}P}$
Output Voltage Set Point (no load)         4.1.5         Vout Voltage Plange (Over Load)         Full resistive load         1         2         mV           Over Load         From no load to full load         5         12         mV           Output Voltage Range (Overall operating input voltage, resistive load and temperature conditions until end of life)         0         2.5         \$-2.5         \$-2.5         \$-8.0	Input Voltage Ripple Rejection	120 Hz		72		dB
Output Regulation¹         Full resistive load         1         2         mV           Over Line         Full resistive load         1         2         mV           Over Load         From no load to full load         5         12         mV           Output Voltage Range (Overaling input voltage, resistive load and temperature conditions until end of life)         2.5         +2.5         *yVourt stand of the present resistive load and temperature (Fig. D)         *yVourt stand of the present resistive load and temperature (Fig. D)         10         20         mVrv-p vourt stand st	Output Characteristics					
Over Line	Output Voltage Set Point (no load)		-1.5	Vout	+1.5	%Vout
Over Load         From no load to full load         5         12         mV           Output Voltage Range (Overall operating input voltage, resistive load and temperature conditions until end of life)         -2.5         +2.5         *8/00 to 400 to 5 A with di/dt = 5 A/μs         Co = 10 μF ceramic + 1 μF ceramic         150 /(180°)         mV           Settling Time (V <sub>OuT</sub> < 10% peak deviation)	Output Regulation <sup>4</sup>					
Output Voltage Range (Overalli operating input voltage, resistive load and temperature conditions until end of life)         -2.5         ±2.5         % Voltation of the post of life in the post	Over Line	Full resistive load		1	2	mV
(Overall operating input voltage, resistive load and temperature conditions until end of life)         42.5         4V.0vt and temperature (Fig. D)           Output Ripple and Noise – 20 MHz bandwidth Peak-to-Peak         Vour = 1.0 VDC         10         20         mV <sub>P-P</sub> Peak-to-Peak         Vour = 5.0 VDC         25         40         mV <sub>P-P</sub> External Load Capacitance         Plus full load (resistive)         1,000         μF           Min ESR > 10 mΩ         15         ADC           Output Current Range         0         10         ADC           Output Current Limit Inception (lour)         3         Arms           Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response         10ut step from 5 A to 10 A with di/dt = 5 A/μs         Co = 10 μF ceramic. + 1 μF ceramic         150/(180°)         mV           Settling Time (Vour < 10% peak deviation)	Over Load	From no load to full load		5	12	mV
Peak-to-Peak         Vour = 1.0 VDC         10         20         mVP-P           Peak-to-Peak         Vour = 5.0 VDC         25         40         mVP-P           External Load Capacitance         Plus full load (resistive)         Tour stand to the property of the part	(Overall operating input voltage, resistive load and temperature conditions until end of life)		-2.5		+2.5	%Vout
Peak-to-Peak         V <sub>OUT</sub> = 5.0 VDC         25         40         mPerpotent means           External Load Capacitance         Plus full load (resistive)         1,000         μF           Min ESR > 1mΩ         1,000         μF           Min ESR > 10 mΩ         5,000         μF           Output Current Range         0         15         ADC           Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response         5         0         15         ADC           Settling Time (Vour < 10% peak deviation)		,				
External Load Capacitance         Plus full load (resistive)           Min ESR > 1 mΩ         1,000         μF           Min ESR > 10 mΩ         1,000         μF           Output Current Range         0         10         ADC           Output Current Limit Inception (lour)         5,000         μF           Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response           Four Externation (Your < 10% peak deviation)         0         150/(180°)         mV           Settling Time (Your < 10% peak deviation)         Co = 10 μF ceramic + 1 μF ceramic         150/(180°)         mV           Settling Time (Your < 10% peak deviation)         Co = 300 μF polymer capacitors         150/(180°)         mV           Settling Time (Your < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120°)         mV           Settling Time (Your < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120°)         mV           Settling Time (Your < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120°)         mV           Settling Time (Your < 10% peak deviation)         Vour = 5.0 VDC         95.0         %           Settling Time (Your < 10% peak deviation)         Vour = 3.0 V	Peak-to-Peak					
Min ESR > 1mΩ         1,000         μF           Min ESR > 10 mΩ         5,000         μF           Output Current Range         0         10         ADC           Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response         Vours Settling Time (Vour < 10% peak deviation)         Co = 10 μF ceramic. + 1 μF ceramic         150/(180%)         mV           Settling Time (Vour < 10% peak deviation)         30         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 10 μF ceramic + 1 μF ceramic         150/(180%)         mV           Settling Time (Vour < 10% peak deviation)         30         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 330 μF polymer capacitors         100/(120%)         mV           Settling Time (Vour < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120%)         mV           Settling Time (Vour < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120%)         mV           Settling Time (Vour < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120%)         mV           Settling Time (Vour < 10% peak deviation)         Vour = 5.0 VDC         95.0         %           Vour = 2.0 VDC         95.0         % <t< td=""><td>Peak-to-Peak</td><td><math>V_{OUT} = 5.0 \text{ VDC}</math></td><td></td><td>25</td><td>40</td><td><math>mV_{P-P}</math></td></t<>	Peak-to-Peak	$V_{OUT} = 5.0 \text{ VDC}$		25	40	$mV_{P-P}$
Min ESR > 10 mΩ         5,000 μF           Output Current Range         0         10         ADC           Output Current Limit Inception (Iour)         15         ADC           Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response         Use tep from 5 A to 10 A with di/dt = 5 A/μs         Co = 10 μF ceramic. + 1 μF ceramic         150/(180⁵)         mV           Settling Time (Vour < 10% peak deviation)	External Load Capacitance	Plus full load (resistive)				
Output Current Range         0         10         ADC           Output Current Limit Inception (Iourr)         15         ADC           Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response           Iout step from 5 A to 10 A with di/dt = 5 A/μs         Co = 10 μF ceramic. + 1 μF ceramic         150/(180°)         mV           Settling Time (Vour < 10% peak deviation)	Min ESR $> 1m\Omega$				1,000	μF
Output Current Limit Inception (Iour)15ADCOutput Short-Circuit CurrentShort = 10 mΩ, continuous3ArmsDynamic ResponseIout step from 5 A to 10 A with di/dt = 5 A/μsCo = 10 μF ceramic. + 1 μF ceramic150/(180 $^5$ )mVSettling Time (Vour < 10% peak deviation)	Min ESR $> 10 \text{ m}\Omega$				5,000	μF
Output Short-Circuit Current         Short = 10 mΩ, continuous         3         Arms           Dynamic Response         Iout step from 5 A to 10 A with di/dt = 5 A/μs         Co = 10 μF ceramic. + 1 μF ceramic         150/(180⁵)         mV           Settling Time (Vouт < 10% peak deviation)         30         μs           Iout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 10 μF ceramic + 1 μF ceramic         150/(180⁵)         mV           Settling Time (Vouт < 10% peak deviation)         30         μs           Iout step from 5 A to 10 with di/dt = 5 A/μs         Co = 330 μF polymer capacitors         100/(120⁵)         mV           Settling Time (Vouт < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120⁵)         mV           Settling Time (Vouт < 10% peak deviation)         Co = 330 μF polymer capacitors         100/(120⁵)         mV           Settling Time (Vouт < 10% peak deviation)         Full load (10 A)         Full load (10 A)         Full load (10 A)         Full load (10 A)         %           Efficiency         Full load (10 A)         %         %         %         %         %           Limit (Vour < 10% peak deviation)         Vour = 5.0 VDC         95.0         %         %         %           Limit (Vour < 10% peak deviation)         Vour = 2.0 VDC         99.0         % <t< td=""><td>Output Current Range</td><td></td><td>0</td><td></td><td>10</td><td>ADC</td></t<>	Output Current Range		0		10	ADC
Dynamic Response   Solution	Output Current Limit Inception (I <sub>OUT</sub> )			15		ADC
lout step from 5 A to 10 A with di/dt = 5 A/μs         Co = 10 μF ceramic. + 1 μF ceramic         150/(180^5)         mV           Settling Time ( $V_{OuT} < 10\%$ peak deviation)         30         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 10 μF ceramic + 1 μF ceramic         150/(180^5)         mV           Settling Time ( $V_{OuT} < 10\%$ peak deviation)         30         μs           lout step from 5 A to 10 with di/dt = 5 A/μs         Co = 330 μF polymer capacitors         100/(120^5)         mV           Settling Time ( $V_{OuT} < 10\%$ peak deviation)         55         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 330 μF polymer capacitors         100/(120^5)         mV           Settling Time ( $V_{OuT} < 10\%$ peak deviation)         55         μs           Efficiency         Full load (10 A)         ***           VouT = 5.0 VDC         95.0         %           VouT = 2.5 VDC         93.0         %           VouT = 2.0 VDC         91.5         %           VouT = 1.8 VDC         90.5         %           VouT = 1.5 VDC         89.5         %           VouT = 1.0 VDC         87.5         %           VouT = 1.0 VDC         86.0         %	Output Short-Circuit Current	Short = $10 \text{ m}\Omega$ , continuous		3		Arms
Settling Time (V <sub>OuT</sub> < 10% peak deviation)         30         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 10 μF ceramic + 1 μF ceramic         150/(180 <sup>5</sup> )         mV           Settling Time (V <sub>OuT</sub> < 10% peak deviation)	Dynamic Response					
lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 10 μF ceramic + 1 μF ceramic         150/(180^5)         mV           Settling Time (Vour < 10% peak deviation)	lout step from 5 A to 10 A with di/dt = $5 \text{ A/}\mu\text{s}$	Co = 10 $\mu$ F ceramic. + 1 $\mu$ F ceramic		150/(180 <sup>5</sup> )		mV
Settling Time (Vouт < 10% peak deviation)         30         μs           lout step from 5 A to 10 with di/dt = 5 A/μs         Co = 330 μF polymer capacitors $100/(120^5)$ mV           Settling Time (Vouт < 10% peak deviation)	Settling Time (V <sub>OUT</sub> < 10% peak deviation)			30		μs
lout step from 5 A to 10 with di/dt = 5 A/μs         Co = 330 μF polymer capacitors         100/(120⁵)         mV           Settling Time ( $V_{OUT} < 10\%$ peak deviation)         55         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 330 μF polymer capacitors         100/(120⁵)         mV           Settling Time ( $V_{OUT} < 10\%$ peak deviation)         55         μs           Efficiency         Full load (10 A)         Vout = 5.0 VDC         95.0         %           Vout = 3.3 VDC         94.0         %           Vout = 2.5 VDC         93.0         %           Vout = 2.5 VDC         91.5         %           Vout = 1.8 VDC         90.5         %           Vout = 1.5 VDC         89.5         %           Vout = 1.2 VDC         87.5         %           Vout = 1.0 VDC         86.0         %	lout step from 10 A to 5 A with di/dt = -5 A/ $\mu$ s	Co = 10 $\mu$ F ceramic + 1 $\mu$ F ceramic		150/(180 <sup>5</sup> )		mV
Settling Time (VouT < 10% peak deviation)         55         μs           lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 330 μF polymer capacitors         100/(1206)         mV           Settling Time (VouT < 10% peak deviation)	Settling Time (Vout < 10% peak deviation)			30		μs
lout step from 10 A to 5 A with di/dt = -5 A/μs         Co = 330 μF polymer capacitors         100/(120⁵)         mV           Settling Time (V <sub>OUT</sub> < 10% peak deviation)         Full load (10 A) $55$ μs           Efficiency         Full load (10 A) $0$ <td>lout step from 5 A to 10 with di/dt = <math>5 \text{ A/}\mu\text{s}</math></td> <td>Co = 330 μF polymer capacitors</td> <td></td> <td>100/(1205)</td> <td></td> <td>mV</td>	lout step from 5 A to 10 with di/dt = $5 \text{ A/}\mu\text{s}$	Co = 330 μF polymer capacitors		100/(1205)		mV
Settling Time (Vout < 10% peak deviation)         55         μs           Efficiency         Full load (10 A)         Full load (10 A)         Full load (10 A)           Vout = 5.0 VDC         95.0         %           Vout = 3.3 VDC         94.0         %           Vout = 2.5 VDC         93.0         %           Vout = 2.0 VDC         91.5         %           Vout = 1.8 VDC         90.5         %           Vout = 1.5 VDC         89.5         %           Vout = 1.2 VDC         87.5         %           Vout = 1.0 VDC         86.0         %	Settling Time (V <sub>OUT</sub> < 10% peak deviation)			55		μs
Efficiency         Full load (10 A)           Vout = 5.0 VDC         95.0         %           Vout = 3.3 VDC         94.0         %           Vout = 2.5 VDC         93.0         %           Vout = 2.0 VDC         91.5         %           Vout = 1.8 VDC         90.5         %           Vout = 1.5 VDC         89.5         %           Vout = 1.2 VDC         87.5         %           Vout = 1.0 VDC         86.0         %	lout step from 10 A to 5 A with di/dt = -5 A/ $\mu$ s	Co = 330 μF polymer capacitors		100/(120 <sup>5</sup> )		mV
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Settling Time (Vout < 10% peak deviation)			55		μs
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Efficiency	Full load (10 A)				
$V_{\text{OUT}} = 2.5 \text{ VDC} \qquad 93.0 \qquad \%$ $V_{\text{OUT}} = 2.0 \text{ VDC} \qquad 91.5 \qquad \%$ $V_{\text{OUT}} = 1.8 \text{ VDC} \qquad 90.5 \qquad \%$ $V_{\text{OUT}} = 1.5 \text{ VDC} \qquad 89.5 \qquad \%$ $V_{\text{OUT}} = 1.2 \text{ VDC} \qquad 87.5 \qquad \%$ $V_{\text{OUT}} = 1.0 \text{ VDC} \qquad 86.0 \qquad \%$		V <sub>OUT</sub> = 5.0 VDC		95.0		%
$V_{OUT} = 2.0 \text{ VDC} \qquad 91.5 \qquad \% \\ V_{OUT} = 1.8 \text{ VDC} \qquad 90.5 \qquad \% \\ V_{OUT} = 1.5 \text{ VDC} \qquad 89.5 \qquad \% \\ V_{OUT} = 1.2 \text{ VDC} \qquad 87.5 \qquad \% \\ V_{OUT} = 1.0 \text{ VDC} \qquad 86.0 \qquad \%$		V <sub>OUT</sub> = 3.3 VDC		94.0		%
$V_{OUT} = 1.8 \text{ VDC}$ 90.5 % $V_{OUT} = 1.5 \text{ VDC}$ 89.5 % $V_{OUT} = 1.2 \text{ VDC}$ 87.5 % $V_{OUT} = 1.0 \text{ VDC}$ 86.0 %		V <sub>OUT</sub> = 2.5 VDC		93.0		%
VOUT = 1.5 VDC       89.5       %         VOUT = 1.2 VDC       87.5       %         VOUT = 1.0 VDC       86.0       %		V <sub>OUT</sub> = 2.0 VDC		91.5		%
$V_{OUT} = 1.5 \text{ VDC}$ 89.5 % $V_{OUT} = 1.2 \text{ VDC}$ 87.5 % $V_{OUT} = 1.0 \text{ VDC}$ 86.0 %		V <sub>OUT</sub> = 1.8 VDC		90.5		%
V <sub>OUT</sub> = 1.2 VDC 87.5 % V <sub>OUT</sub> = 1.0 VDC 86.0 %		***				
V <sub>OUT</sub> = 1.0 VDC 86.0 %		Vour = 1.2 VDC		87.5		%
		***				
		Vout = 0.7525 VDC		84.0		%

#### Notes:

- <sup>1</sup> The output voltage should not exceed 5.5 VDC.
- Note that the startup time is the sum of turn-on delay time and rise time.
- <sup>3</sup> The converter is ON if the ON/OFF pin is left open.
- <sup>4</sup> Trim resistor connected across the GND and TRIM pins of the converter.
- <sup>5</sup> For V<sub>OUT</sub> = 5.0 VDC only. See the waveforms section for dynamic response and settling time for different output voltages.



### **Operations**

#### **Input and Output Impedance**

Y-Series converter should be connected via a low impedance to the DC power source. In many applications, the inductance associated with the distribution from the power source to the input of the converter can affect the stability of the converter. It is recommended to use decoupling capacitors (minimum 47  $\mu$ F) placed as close as possible to the converter's input pins in order to ensure stability of the converter and reduce input ripple voltage. Internally, the converter has 20  $\mu$ F (low ESR ceramics) of input capacitance.

In a typical application, low - ESR tantalum or POS capacitors will be sufficient to provide adequate ripple voltage filtering at the input of the converter. However, very low ESR ceramic capacitors

47 to  $100 \mu$ F are recommended at the input of the converter in order to minimize the input ripple voltage. They should be placed as close as possible to the input pins of the converter.

The YNS12S10 has been designed for stable operation with or without external capacitance. Low ESR ceramic capacitors placed as close as possible to the load (minimum 47  $\mu$ F) are recommended for better transient performance and lower output voltage ripple.

It is important to keep low resistance and low inductance PCB traces for connecting your load to the output pins of the converter. This is required to maintain good load regulation since the converter does not have a SENSE pin for compensating voltage drops associated with the power distribution system on your PCB.

#### ON/OFF (Pin 1)

The ON/OFF pin (Pin 1) is used to turn the power converter on or off remotely via a system signal. There are two remote control options available, positive logic (standard option) and negative logic, with both are referenced to GND (Pin 5). The typical connections are shown in Fig. A.

The positive logic version turns the converter on when the ON/OFF pin is at a logic high or left open, and turns the converter off when at a logic low or shorted to GND.

The negative logic version turns the converter on when the ON/OFF pin is at a logic low or left open, and turns the converter off when the ON/OFF pin is at a logic high or connected to Vin.

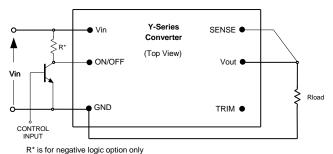


Fig. A: Circuit configuration for ON/OFF function.

The ON/OFF pin is internally pulled up to Vin for a positive logic version, and pulled down for a negative logic version. A TTL or CMOS logic gate, open-collector (open-drain) transistor can be used to drive the ON/OFF pin. When using open-collector (open-drain) transistor with a negative logic option, add a pull-up resistor (R\*) of 75 k $\Omega$  to Vin as shown in Fig. A. This device must be capable of:

- sinking up to 0.2 mA at a low level voltage of ≤ 0.8 V
- sourcing up to 0.25 mA at a high logic level of 2.3 to 5 V
- sourcing up to 0.75 mA when connected to Vin

#### Remote Sense (Pin 2)

The remote sense feature of the converter compensates for voltage drops occurring only between Vout pin (Pin 4) of the converter and the load. The SENSE (Pin 2) pin should be connected at the load or at the point where regulation is required (see Fig. B). There is no sense feature on the output GND return pin, where the solid ground plane should provide low voltage drop.

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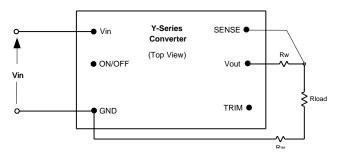


Fig. B: Circuit configuration for ON/OFF function.

If remote sensing is not required, the SENSE pin must be connected to the Vout pin (Pin 4) to ensure the converter will regulate at the specified output voltage. If these connections are not made, the converter will deliver an output voltage that is slightly higher than the specified value.

Because the sense lead carries minimal current, large traces on the end-user board are not required. However, sense trace should be located close to a ground plane to minimize system noise and ensure the optimum performance.

When utilizing the remote sense feature, care must be taken not to exceed the maximum allowable output power capability of the converter which is equal to the product of the nominal output voltage and the allowable output current for the given conditions.

When using remote sense, the output voltage at the converter can be increased up to 0.5 V above the nominal rating in order to maintain the required voltage across the load. Therefore, the designer must, if necessary, decrease the maximum current (originally obtained from the derating curves) by the same percentage to ensure the converter's actual output power remains at or below the maximum allowable output power.

#### **Output Voltage Programming (Pin 3)**

The output voltage can be programmed from

0.7525 to 5.5 V by connecting an external resistor between TRIM pin (Pin 3) and GND pin (Pin 5); see Fig. C. Note that when trim resistor is not connected, output voltage of the converter is 0.7525 V.

A trim resistor, R<sub>TRIM</sub>, for a desired output voltage can be calculated using the following equation:

$$R_{TRIM} = \frac{10.5}{(V_{O-REQ} - 0.7525)} - 1$$
 [k\O]

where,

**R**TRIM = Required value of trim resistor  $[k\Omega]$ 

**Vo-REQ** = Desired (trimmed) output voltage [V]

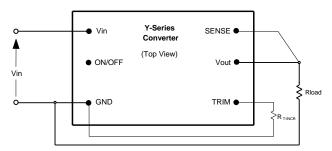


Fig. C: Configuration for programming output voltage.

Note that the tolerance of a trim resistor directly affects the output voltage tolerance. It is recommended to use standard 1% or 0.5% resistors; for tighter tolerance, two resistors in parallel are recommended rather than one standard value from Table 1.

The ground pin of the trim resistor should be connected directly to the converter GND pin (Pin 5) with no voltage drop in between. Table 1 provides the trim resistor values for popular output voltages.



Table 1: Trim Resistor Value

<b>V</b> <sub>0-REG</sub> [V]	R <sub>TRIM</sub> [kΩ]	The Closest Standard Value [kΩ]
0.7525	open	
1.0	41.42	41.2
1.2	22.46	22.6
1.5	13.05	13.0
1.8	9.02	9.09
2.0	7.42	7.50
2.5	5.01	4.99
3.3	3.12	3.09
5.0	1.47	1.47
5.5	1.21	1.21

The output voltage can also be programmed by external voltage source. To make trimming less sensitive, a series external resistor Rext is recommended between TRIM pin and programming voltage source. Control Voltage can be calculated by the formula:

$$V_{\text{CTRL}} = 0.7 - \frac{(1 + \text{Rext})(V_{\text{O-REQ}} - 0.7525)}{15}$$
 [V]

where

**V**CTRL = Control voltage [V]

 $\mathbf{R}_{\text{EXT}}$  = External resistor between TRIM pin and voltage source; the  $k\Omega$  value can be chosen depending on the required output voltage range.

Control voltages with  $\mathbf{R}\mathbf{ext} = 0$  and  $\mathbf{R}\mathbf{ext} = 15 \text{ k}\Omega$  are shown in Table 2.

Table 2: Control Voltage [VDC]

V <sub>0-REG</sub> [V]	V <sub>CTRL</sub> (R <sub>EXT</sub> = 0)	$V_{CTRL}(R_{EXT} = 15 \text{ k}\Omega)$
0.7525	0.700	0.700
1.0	0.684	0.436
1.2	0.670	0.223
1.5	0.650	-0.097
1.8	0.630	-0.417
2.0	0.617	-0.631
2.5	0.584	-1.164
3.3	0.530	-2.017
5.0	0.417	-3.831
5.5	0.384	-4.364

#### **Protection Features**

#### **Input Undervoltage Lockout**

Input undervoltage lockout is standard with this converter. The converter will shut down when the input voltage drops below a pre-determined voltage; it will start automatically when Vin returns to a specified range.

The input voltage must be typically 9.0 V for the converter to turn on. Once the converter has been turned on, it will shut off when the input voltage drops below typically 8.5 V.

#### **Output Overcurrent Protection (OCP)**

The converter is protected against overcurrent and short circuit conditions. Upon sensing an overcurrent condition, the converter will enter hiccup mode. Once overload or short circuit condition is removed, Vout will return to nominal value.



#### **Overtemperature Protection (OTP)**

The converter will shut down under an overtemperature condition to protect itself from overheating caused by operation outside the thermal derating curves, or operation in abnormal conditions such as system fan failure. After the converter has cooled to a safe operating temperature, it will automatically restart.

#### **Safety Requirements**

The converter meets North American and International safety regulatory requirements per UL60950 and EN60950. The maximum DC voltage between any two pins is Vin under all operating conditions. Therefore, the unit has ELV (extra low voltage) output; it meets SELV requirements under the condition that all input voltages are ELV. The converter is not internally fused. To comply with safety agencies' requirements, a recognized fuse with a maximum rating of 15 Amps must be used in series with the input line.

#### **Characterization**

#### **General Information**

The converter has been characterized for many operational aspects, to include thermal derating (maximum load current as a function of ambient temperature and airflow) for vertical and horizontal mountings, efficiency, startup and

shutdown parameters, output ripple and noise, transient response to load step-change, overload, and short circuit. The figures are numbered as Fig. x.y, where x indicates the different output voltages, and y associates with specific plots (y = 1 for the vertical thermal derating, ...). For example, Fig. x.1 will refer to the vertical thermal derating for all the output voltages in general.

The following pages contain specific plots or waveforms associated with the converter. Additional comments for specific data are provided below.

#### **Test Conditions**

All data presented were taken with the converter soldered to a test board, specifically a 0.060" thick printed wiring board (PWB) with four layers. The top and bottom layers were not metalized. The two inner layers, comprised of two-ounce copper, were used to provide traces for connectivity to the converter.

The lack of metalization on the outer layers as well as the limited thermal connection ensured that heat transfer from the converter to the PWB was minimized. This provides a worst-case but consistent scenario for thermal derating purposes.

All measurements requiring airflow were made in the vertical and horizontal wind tunnels using Infrared (IR) thermography and thermocouples for thermometry.

Ensuring components on the converter do not exceed their ratings is important to maintaining high reliability. If one anticipates operating the converter at or close to the maximum loads specified in the derating curves, it is prudent to check actual operating temperatures in the application. Thermographic imaging is preferable; if this capability is not available, then thermocouples may be used. The use of AWG #40 gauge thermocouples is recommended to ensure measurement accuracy. Careful routing of the thermocouple leads will further minimize measurement error. Refer to Fig. D for the optimum measuring thermocouple location.

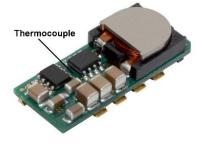


Fig. D: Location of the thermocouple for thermal testing.



#### **Thermal Derating**

Load current vs. ambient temperature and airflow rates are given in Figs. x.1 to x.2 for maximum temperature of 110°C. Ambient temperature was varied between 25 °C and 85 °C, with airflow rates from 30 to 500 LFM (0.15 m/s to 2.5 m/s), and vertical and horizontal converter mountings. The airflow during the testing is parallel to the long axis of the converter, going from pin 1 and pin 6 to pins 2–5.

For each set of conditions, the maximum load current is defined as the lowest of:

- (i) The output current at which any MOSFET temperature does not exceed a maximum specified temperature (110 °C) as indicated by the thermographic image, or
- (ii) The maximum current rating of the converter (10 A)

During normal operation, derating curves with maximum FET temperature less than or equal to 110 °C should not be exceeded. Temperature on the PCB at the thermocouple location shown in Fig. D should not exceed 110 °C in order to operate inside the derating curves.

#### **Efficiency**

Figure x.3 shows the efficiency vs. load current plot for ambient temperature of 25  $^{\circ}$ C, airflow rate of 200 LFM (1 m/s) and input voltages of 9.6 V, 12 V, and 14 V.

#### **Power Dissipation**

Fig. x.4 shows the power dissipation vs. load current plot for Ta = 25 °C, airflow rate of 200 LFM (1 m/s) with vertical mounting and input voltages of 9.6 V, 12 V, and 14 V.

#### **Ripple and Noise**

The output voltage ripple waveform is measured at full rated load current. Note that all output voltage waveforms are measured across a 1  $\mu$ F ceramic capacitor.

The output voltage ripple and input reflected ripple current waveforms are obtained using the test setup shown in Figure E.

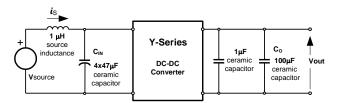


Fig. E: Test Setup for measuring input reflected-ripple currents, is and output voltage ripple.



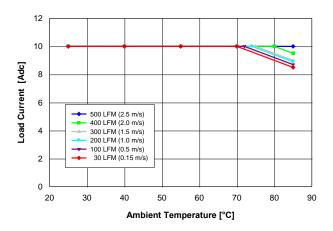


Fig. 5.0V.1: Available load current vs. ambient temperature and airflow rates for Vout = 5.0 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

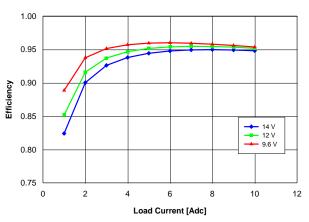


Fig. 5.0V.3: Efficiency vs. load current and input voltage for Vout = 5.0 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

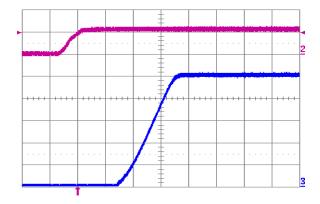


Fig. 5.0V.5: Turn-on transient for Vout = 5.0 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

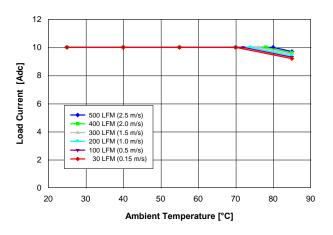


Fig. 5.0V.2: Available load current vs. ambient temperature and airflow rates for Vout = 5.0 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

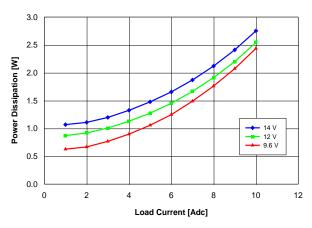


Fig. 5.0V.4: Power Loss vs. load current and input voltage for Vout = 5.0 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

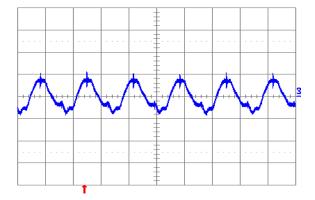


Fig. 5.0V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \,\mu F$  ceramic +  $1 \,\mu F$  ceramic, and Vin =  $12 \,V$  for Vout =  $5.0 \,V$ . Time scale:  $2 \,\mu s$ /div.



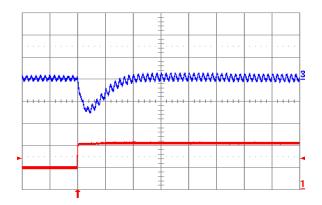


Fig. 5.0V.7: Output voltage response for Vout = 5.0 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

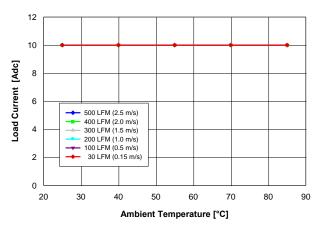


Fig. 3.3V.1: Available load current vs. ambient temperature and airflow rates for Vout = 3.3 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

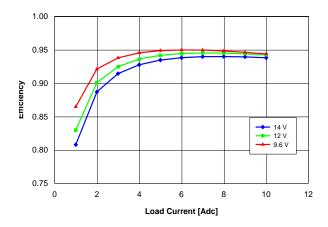


Fig. 3.3V.3: Efficiency vs. load current and input voltage for Vout = 3.3 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

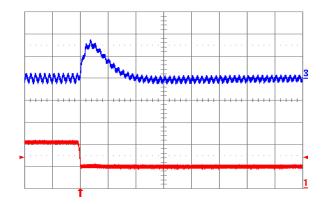


Fig. 5.0V.8: Output voltage response for Vout = 5.0 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

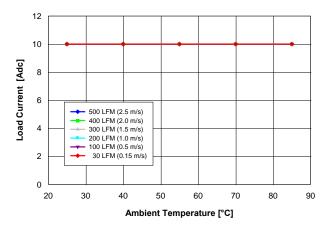


Fig. 3.3V.2: Available load current vs. ambient temperature and airflow rates for Vout = 3.3 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

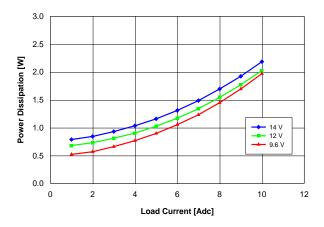


Fig. 3.3V.4: Power Loss vs. load current and input voltage for Vout = 3.3 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.



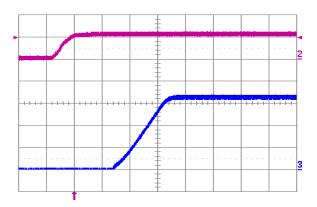


Fig. 3.3V.5: Turn-on transient for Vout = 3.3 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

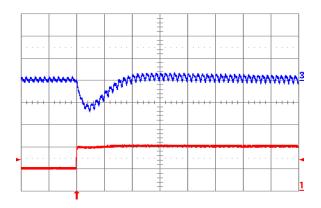


Fig. 3.3V.7: Output voltage response for Vout = 3.3 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

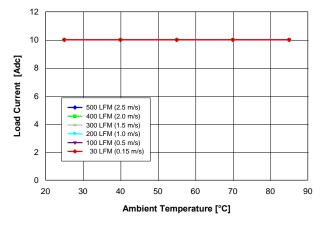


Fig. 2.5V.1: Available load current vs. ambient temperature and airflow rates for Vout = 2.5 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

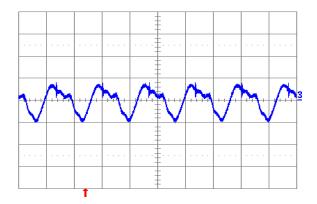


Fig. 3.3V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance 100  $\mu$ F ceramic + 1  $\mu$ F ceramic, and Vin = 12 V for Vout = 3.3 V. Time scale: 2  $\mu$ s/div.

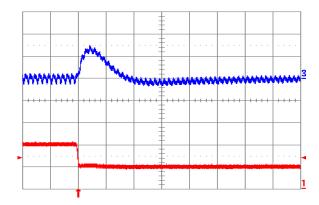


Fig. 3.3V.8: Output voltage response for Vout = 3.3 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (2 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

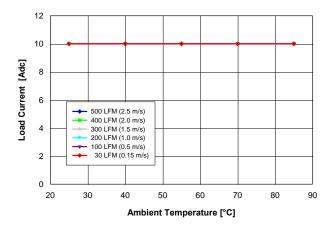


Fig. 2.5V.2: Available load current vs. ambient temperature and airflow rates for Vout = 2.5 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

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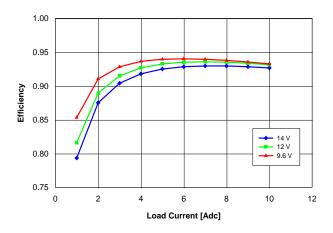


Fig. 2.5V.3: Efficiency vs. load current and input voltage for Vout = 2.5 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

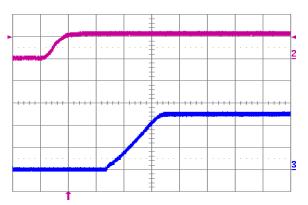


Fig. 2.5V.5: Turn-on transient for Vout = 2.5 V with application of Vin at full rated load current (resistive) and 47 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

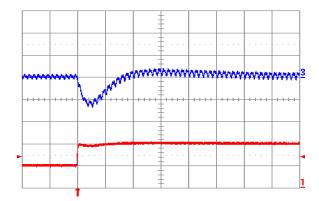


Fig. 2.5V.7: Output voltage response for Vout = 2.5 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

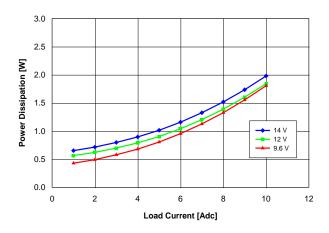


Fig. 2.5V.4: Power Loss vs. load current and input voltage for Vout = 2.5 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

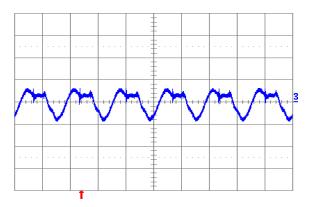


Fig. 2.5V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \, \mu F$  ceramic +  $1 \, \mu F$  ceramic, and  $Vin = 12 \, V$  for  $Vout = 2.5 \, V$ . Time scale:  $2 \, \mu s/div$ .

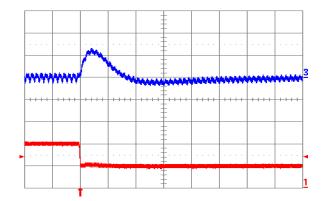


Fig. 2.5V.8: Output voltage response for Vout = 2.5 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.



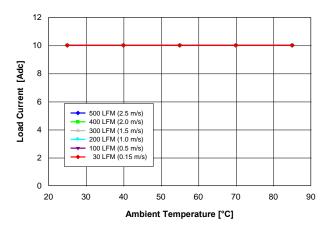


Fig. 2.0V.1: Available load current vs. ambient temperature and airflow rates for Vout = 2.0 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

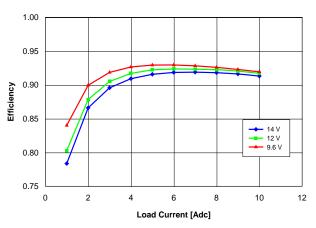


Fig. 2.0V.3: Efficiency vs. load current and input voltage for Vout = 2.0 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

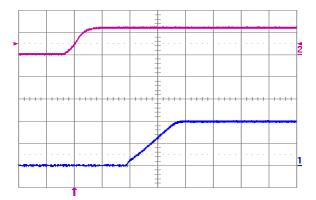


Fig. 2.0V.5: Turn-on transient for Vout = 2.0 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

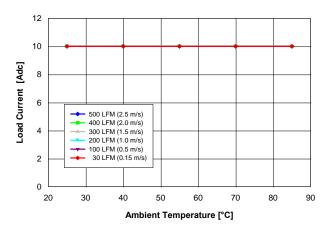


Fig. 2.0V.2: Available load current vs. ambient temperature and airflow rates for Vout = 2.0 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

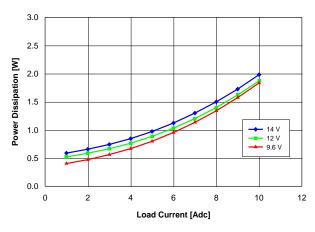


Fig. 2.0V.4: Power Loss vs. load current and input voltage for Vout = 2.0 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

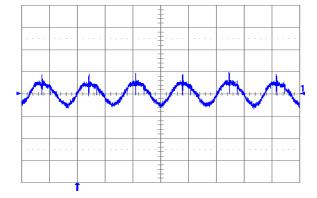


Fig. 2.0V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \, \mu F$  ceramic +  $1 \, \mu F$  ceramic, and  $Vin = 12 \, V$  for  $Vout = 2.0 \, V$ . Time scale:  $2 \, \mu s$ /div.



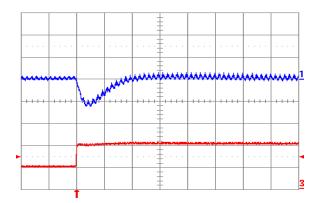


Fig. 2.0V.7: Output voltage response for Vout = 2.0 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

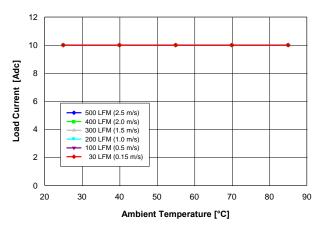


Fig. 1.8V.1: Available load current vs. ambient temperature and airflow rates for Vout = 1.8 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

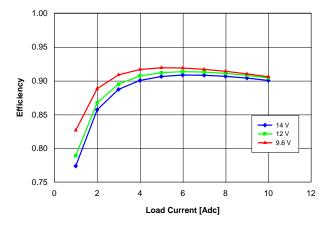


Fig. 1.8V.3: Efficiency vs. load current and input voltage for Vout = 1.8 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

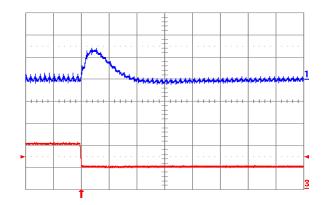


Fig. 2.0V.8: Output voltage response for Vout = 2.0 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

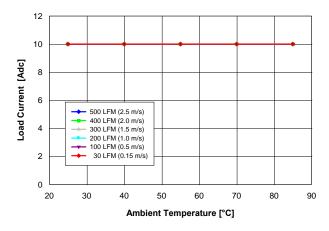


Fig. 1.8V.2: Available load current vs. ambient temperature and airflow rates for Vout = 1.8 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

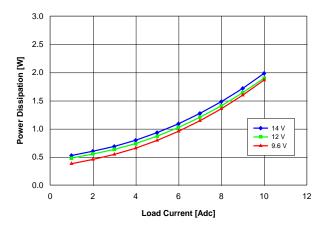


Fig. 1.8V.4: Power Loss vs. load current and input voltage for Vout = 1.8 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.



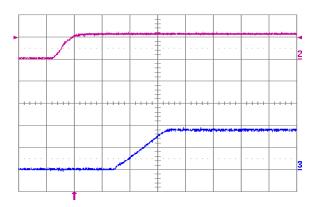


Fig. 1.8V.5: Turn-on transient for Vout = 1.8 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

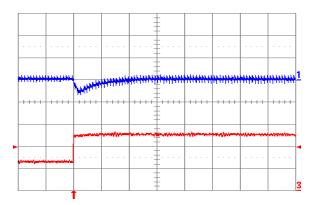


Fig. 1.8V.7: Output voltage response for Vout = 1.8 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

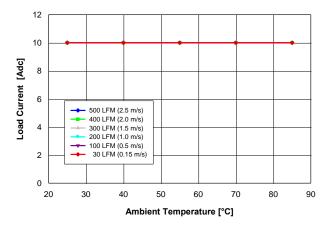


Fig. 1.5V.1: Available load current vs. ambient temperature and airflow rates for Vout = 1.5 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

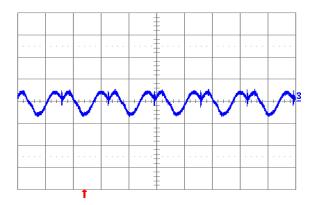


Fig. 1.8V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \,\mu\text{F}$  ceramic +  $1 \,\mu\text{F}$  ceramic, and  $Vin = 12 \,V$  for  $Vout = 1.8 \,V$ . Time scale:  $2 \,\mu\text{s}/\text{div}$ .

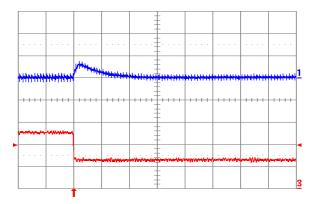


Fig. 1.8V.8: Output voltage response for Vout = 1.8 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

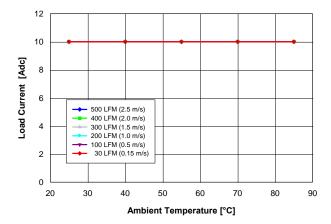


Fig. 1.5V.2: Available load current vs. ambient temperature and airflow rates for Vout = 1.5 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.



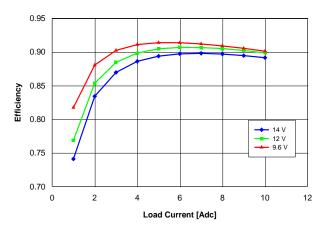


Fig. 1.5V.3: Efficiency vs. load current and input voltage for Vout = 1.5 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

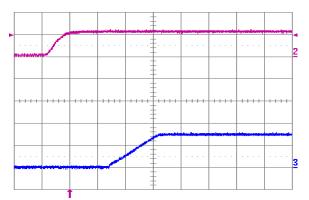


Fig. 1.5V.5: Turn-on transient for Vout = 1.5 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div

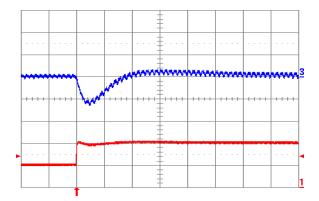


Fig. 1.5V.7: Output voltage response for Vout = 1.5 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (2 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

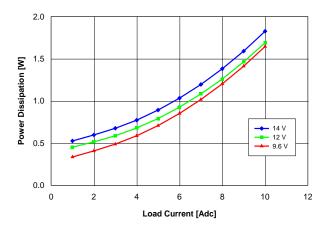


Fig. 1.5V.4: Power Loss vs. load current and input voltage for Vout = 1.5 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

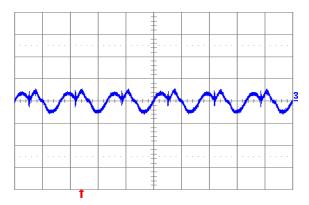


Fig. 1.5V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \, \mu F$  ceramic +  $1 \, \mu F$  ceramic, and  $Vin = 12 \, V$  for  $Vout = 1.5 \, V$ . Time scale:  $2 \, \mu s$ /div.

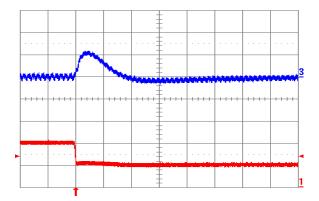


Fig. 1.5V.8: Output voltage response for Vout = 1.5 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (2 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.



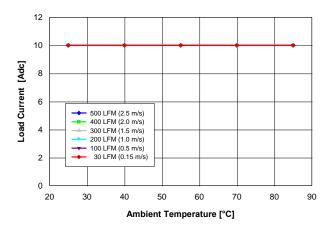


Fig. 1.2V.1: Available load current vs. ambient temperature and airflow rates for Vout = 1.2 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

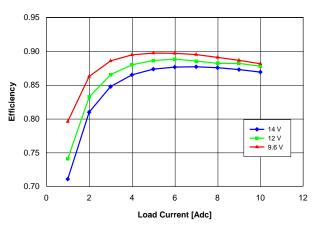


Fig. 1.2V.3: Efficiency vs. load current and input voltage for Vout = 1.2 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

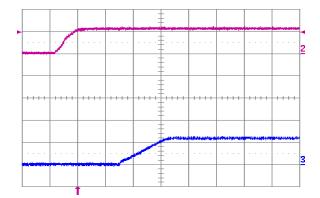


Fig. 1.2V.5: Turn-on transient for Vout = 1.2 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 5 ms/div.

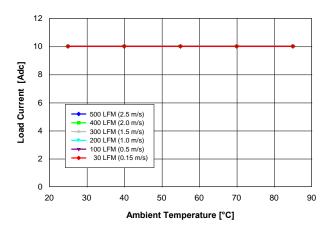


Fig. 1.2V.2: Available load current vs. ambient temperature and airflow rates for Vout = 1.2 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

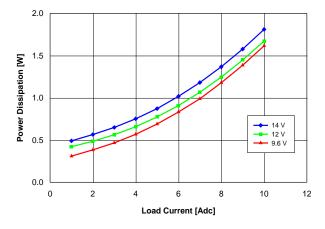


Fig. 1.2V.4: Power Loss vs. load current and input voltage for Vout = 1.2 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

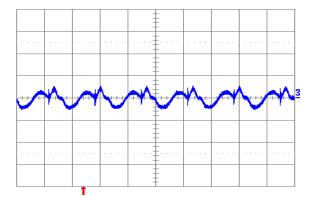


Fig. 1.2V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \, \mu F$  ceramic +  $1 \, \mu F$  ceramic, and  $Vin = 12 \, V$  for  $Vout = 1.2 \, V$ . Time scale:  $2 \, \mu s$ /div.



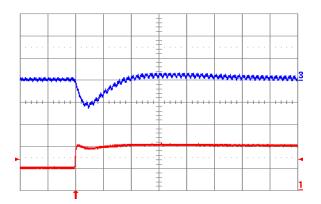


Fig. 1.2V.7: Output voltage response for Vout = 1.2 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

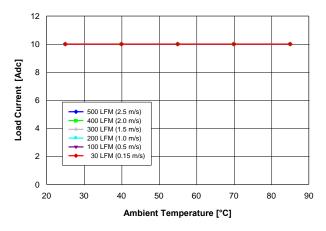


Fig. 1.0V.1: Available load current vs. ambient temperature and airflow rates for Vout = 1.0 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

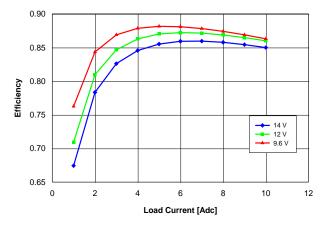


Fig. 1.0V.3: Efficiency vs. load current and input voltage for Vout = 1.0 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

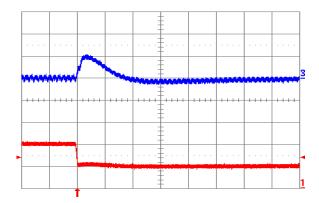


Fig. 1.2V.8: Output voltage response for Vout = 1.2 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

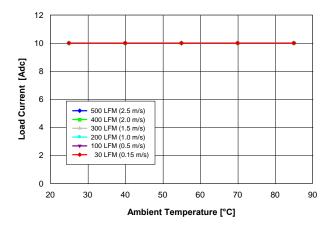


Fig. 1.0V.2: Available load current vs. ambient temperature and airflow rates for Vout = 1.0 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

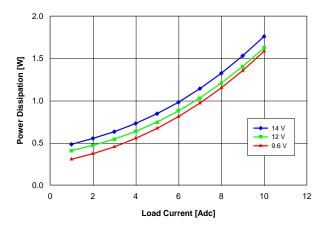


Fig. 1.0V.4: Power Loss vs. load current and input voltage for Vout = 1.0 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.



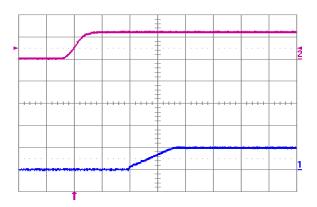


Fig. 1.0V.5: Turn-on transient for Vout = 1.0 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

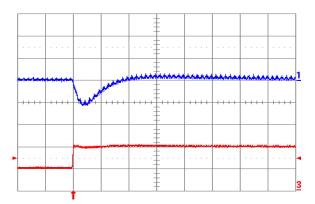


Fig. 1.0V.7: Output voltage response for Vout = 1.0 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

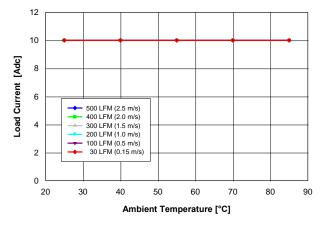


Fig. 0.7525V.1: Available load current vs. ambient temperature and airflow rates for Vout = 0.7525 V converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.

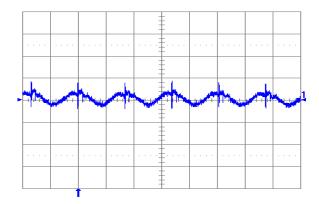


Fig. 1.0V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \, \mu F$  ceramic +  $1 \, \mu F$  ceramic, and  $Vin = 12 \, V$  for  $Vout = 1.0 \, V$ . Time scale:  $2 \, \mu s$ /div.

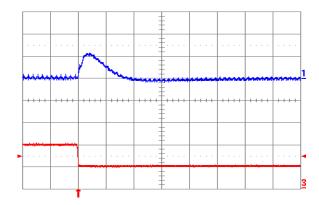


Fig. 1.0V.8: Output voltage response for Vout = 1.0 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

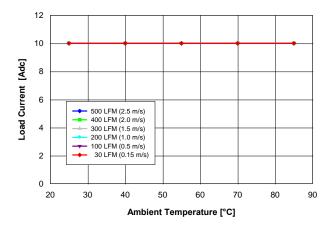


Fig. 0.7525V.2: Available load current vs. ambient temperature and airflow rates for Vout = 0.7525 V converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 110 °C.



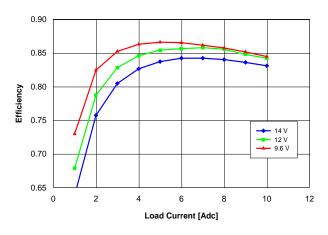


Fig. 0.7525V.3: Efficiency vs. load current and input voltage for Vout = 0.7525 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

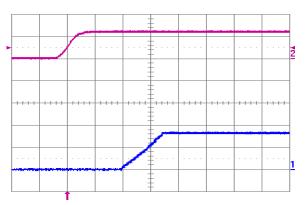


Fig. 0.7525V.5: Turn-on transient for Vout = 0.7525 V with application of Vin at full rated load current (resistive) and 100 μF external capacitance at Vin = 12 V. Top trace: Vin (10 V/div.); Bottom trace: output voltage (0.5 V/div.); Time scale: 2 ms/div.

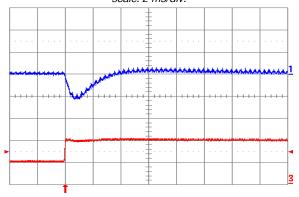


Fig. 0.7525V.7: Output voltage response for Vout = 0.7525 V to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

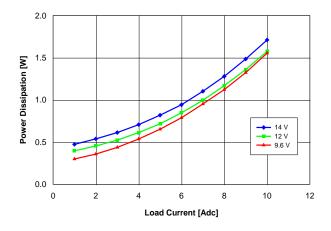


Fig. 0.7525V.4: Power Loss vs. load current and input voltage for Vout = 0.7525 V converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

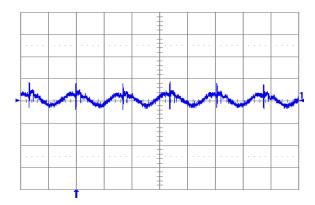


Fig. 0.7525V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance  $100 \,\mu\text{F}$  ceramic +  $1 \,\mu\text{F}$  ceramic, and Vin =  $12 \,\text{V}$  for Vout =  $0.7525 \,\text{V}$ . Time scale:  $2 \,\mu\text{s}/\text{div}$ .

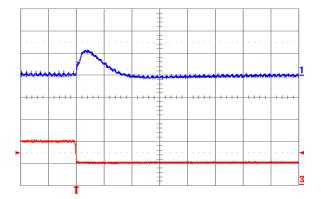
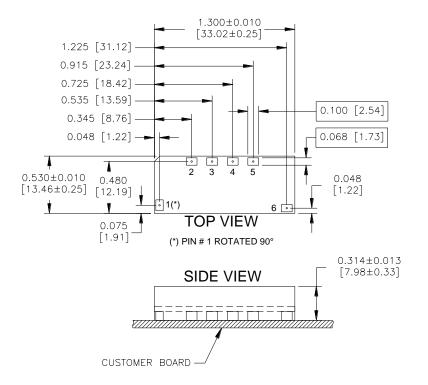


Fig. 0.7525V.8: Output voltage response for Vout = 0.7525 V to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.



#### **Physical Information**



PAD/PIN CONNECTIONS			
Function			
ON/OFF			
SENSE			
TRIM			
Vout			
GND			
Vin			

#### YNS12S Platform Notes

- All dimensions are in inches [mm]
- Connector Material: Copper
- Connector Finish: Gold over Nickel
- Converter Weight: 0.22 oz [6.12 g]
- Converter Height: 0.327" Max., 0.301" Min.
- Recommended Surface-mount Pads: Min. 0.080" X 0.112" [2.03 x 2.84]

YNS05S Pinout (Surface Mount)

### **Ordering Information**

Product Series	Input Voltage	Mounting Scheme	Rated Load Current	Enable Logic	Environmental
YNS	12	S	10 -	0	
Y-Series	9.6 to14 VDC	S ⇒ Surface- Mount	10 A (0.7525 to 5.5 VDC)	0 ⇒ Standard (Positive Logic)  D ⇒ Opposite of Standard (Negative Logic)	No Suffix ⇒ RoHS lead-solder-exempt compliant  G ⇒ RoHS compliant for all six substances

The example above describes P/N YNS12S10-0: 9.6 to 14 VDC input, surface-mount, 10 A at 0.7525 to 5.5 VDC output, standard (positive logic), and Eutectic Tin/Lead solder. Please consult factory regarding availability of a specific version.

The YNS12S10 is not recommended for new designs and has been replaced by the YS12S10.

Please refer to the YS12S10 data sheet for new product specifications.

### For more information on these products consult: tech.support@psbel.com

**NUCLEAR AND MEDICAL APPLICATIONS** - Products are not designed or intended for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems.

**TECHNICAL REVISIONS** - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.



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PSE1000DCDC-12V RDS180245 MAU228 419-2065-201 449-2075-101 V300C24C150BG 419-2062-200 419-2063-401 419-2067-101
419-2067-501 419-2068-001 DFC15U48D15 449-2067-000 XGS-0512 XGS-1212 XGS-1212 XGS-2412 XGS-2415 XKS-1215 033456
NCT1000N040R050B SPB05B-15 SPB05C-15 VI-26B-CU V24C12C100BG L-DA20 HP3040-9RG HP1001-9RTG DCG40-5G XKS2415 XKS-2412